

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,873,236 B2
DATED : March 29, 2005
INVENTOR(S) : Manoj R. Shah et al.

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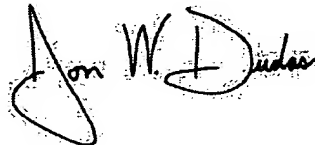
It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 8,

Line 44, please delete "copper and insulation layer on at least of the copper" and insert -- copper and insulation layer on at least one surface of the copper --

Signed and Sealed this

Ninth Day of August, 2005

A handwritten signature in black ink, appearing to read "Jon W. Dudas". The signature is stylized with a large, looped initial "J" and a distinct "D".

JON W. DUDAS
Director of the United States Patent and Trademark Office